

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings of claims in the application:

Claims 1-2 (Canceled).

Claim 3 (Previously Presented) A floor polishing composition, comprising:
a film-formable organic resin material as the main component, and
scaly particles,
wherein said scaly particles are silica corresponding to layered polysilicic acid,
wherein said layered polysilicic acid has layered particle structures that are present independently from each other,
wherein said layered polysilicic acid comprises foliar silica secondary particles that are present discretely from each other,
wherein a plurality of flaky primary particles of scaly silica are overlaid one on another and aligned face-to-face in parallel with one another, and
wherein the foliar silica secondary particles are obtained by disintegrating an aqueous slurry of tertiary agglomerated particles of silica by means of a mechanical high speed stirring system employing a disintegrating medium.

Claim 4 (Canceled).

Claim 5 (Original): The floor polishing composition according to Claim 3, wherein the foliar silica secondary particles composing the scaly silica are silica having the main peaks corresponding to silica-X and/or silica-Y according to X-ray diffraction analysis.

Claim 6-7 (Canceled).

Claim 8 (Previously Presented): The floor polishing composition according to Claim 3, wherein the organic resin material in the floor polishing composition is an organic resin material in aqueous emulsion state.

Claim 9 (Canceled).

Claim 10 (Previously Presented): The floor polishing composition according to Claim 5, wherein the organic resin material in the floor polishing composition is an organic resin material in aqueous emulsion state.

Claim 11 (Currently Amended): A floor polishing film, comprising:
a film-formable organic resin material provided on a surface of a substrate, which resin material contains scaly particles;
wherein said scaly particles are silica corresponding to layered polysilicic acid,
wherein said layered polysilicic acid has layered particle structures that are present independently from each other,
wherein said layered polysilicic acid comprises foliar silica secondary particles that are present discretely from each other,
wherein a plurality of flaky primary particles of scaly silica are overlaid one on another and aligned face-to-face in parallel with one another.

Claim 12 (Canceled):

Claim 13 (Canceled):

Claim 14 (Currently Amended): The floor polishing film according to Claim [[12]] 11, wherein the foliar silica secondary particles composing scaly silica in the film are silica having the main peaks corresponding to silica-X and/or silica-Y according to x-ray diffraction analysis.

Claim 15 (Canceled):

Claim 16 (Previously Presented): A floor polishing film according to Claim 11, wherein an overcoating layer comprising an organic resin material is provided on the floor polishing film.

Claim 17 (Canceled):

Claim 18 (Canceled):

Claim 19 (Previously Presented): A floor polishing film according to Claim 14, wherein an overcoating layer comprising an organic resin material is provided on the floor polishing film.

Claim 20 (Canceled):

Claim 21 (Currently Amended): A method of treating a floor, comprising:

applying a floor polishing composition according to Claim 11 ~~containing a film-formable organic resin material as the main component, which further contains at least sealy particles,~~ to the floor.

Claim 22 (Canceled):

Claim 23 (Previously Presented): A method of treating a floor comprising applying the floor polishing composition of Claim 3 to the floor.

Claim 24 (Previously Presented): A method of treating a floor comprising applying the floor polishing composition of Claim 5 to the floor.

Claim 25 (Previously Presented): A method of treating a floor comprising applying the floor polishing composition of Claim 8 to the floor.

Claim 26 (Previously Presented): A method of treating a floor comprising applying the floor polishing composition of Claim 10 to the floor.

Claim 27 (Currently Amended): A floor polishing film according to Claim 11,
~~wherein said sealy particles are silica corresponding to layered polysilicic acid,~~
~~wherein said layered polysilicic acid has layered particle structures that are present independently from each other,~~
~~wherein said layered polysilicic acid comprises foliar silica secondary particles that are present discretely from each other,~~

~~wherein a plurality of flaky primary particles of scaly silica are overlaid one on another and aligned face to face in parallel with one another, and~~

wherein the foliar silica secondary particles are obtained by disintegrating an aqueous slurry of tertiary agglomerated particles of silica by means of a mechanical high speed stirring system employing a disintegrating medium.

Claim 28 (New): The floor polishing film according to Claim 27, wherein the foliar silica secondary particles composing scaly silica in the film are silica having the main peaks corresponding to silica-X and/or silica-Y according to x-ray diffraction analysis.

Claim 29 (New): A floor polishing film according to Claim 27, wherein an overcoating layer comprising an organic resin material is provided on the floor polishing film.

Claim 30 (New): A floor polishing film according to Claim 28, wherein an overcoating layer comprising an organic resin material is provided on the floor polishing film.

BASIS FOR THE AMENDMENT

Claims 12, 13, 15, 17, 18, 20 and 22 have been canceled.

The limitations of Claims 12 and 13 have been included in Claim 11.

Claim 27 has been amended to delete limitations already present in Claim 11.

New Claims 28-30 have been added as supported by Claims 14 and 16 as originally filed.

No new matter is believed to have been added by entry of this amendment. Entry and favorable reconsideration are respectfully requested.

Upon entry of this amendment Claims 3, 5, 8 and 10, 11, 14, 16, 19, 21, and 23-30 will now be active in this application.